Roll No.

328731(28)

B. E. (Seventh Semester) Examination, Nov.-Dec. 2021

(New Scheme)

(ET&T Engg. Branch)

MICROWAVE COMMUNICATION and ENGINEERING

Time Allowed: Three hours

Maximum Marks: 80

Minimum Pass Marks: 28

Note: Part (a) of each unit is compulsory. Attempt any two parts from (b), (c) and (d) from each unit.

Unit-I

- 1. (a) What is the function of slow wave structure in TWT? 2
 - (b) Explain reason of failure of conventional tubes at microwave frequencies.

PTO

	diagram. Also explain velocity modulation and	
	bunching process.	7
(d)	A Reflex Klystron has the following parameters:	
	$V_0 = 800$ volt, $L = 1.5$ mm, $Rsh = 15 k \Omega$, $F = 9$	
	GHz.	7
	Calculate:	
	promoval agent 1 Mal ()	
	(i) Repeller voltage for $1\frac{3}{4}$ mode.	
	(ii) Direct current necessary to give microwave gap	
	voltage of 200 volt.	
	(iii) Efficiency.	
	Assume $\beta = 1$ and for $X' = 1.841$, $J_1(X') = 0.582$	
	Unit-II	
(a)	What are the differences between linear beam tubes	
	and crossed field tubes?	2
(b)	Derive an expression for Hull cut-off voltage and	
	Hull cut-off magnetic flux density for cavity	
	magnetron.	7

(c) Derive an expression for power output and efficiency	
of forward cross field amplifier.	7
(d) A pulsed cylindrical magnetron is operated with the	
read following parameters:	7
Beam current = 27 amp.	
Anode voltage = 26 k volt	
Magnetic flux density = 0.336 Wb/m^3	
Radius of cathode cylinder = 5 cm	
Radius of anode cylinder = 10 cm	
Calculate:	
(i) The angular frequency	
(ii) The cut-off voltage	
(iii) The cut-off magnetic flux density	
manufacture of the subsect of the su	
(a) What are the advantages of JFET over BJT?	2
(b) Withe the help of schematic diagram explain how	
PIN diode used as : "	7
(i) Switch	

2.

3.

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	41	
	7	
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		(ii) Phase shiffer	
		(iii) Amplitude modulation	
	(c)	What are MESFET? Explain the construction, operation, performance characteristics and their applications.	7
	(d)	Explain the principle of operation for Tunnel diode with the help of energy band diagram.	7
		Unit-IV	
4.	(a)	Which material is used is Gunn diode and why?	2
	(b)	Explain the operation of IMPATT diode an compare with TRAPATT diode.	7
	(c)	Explain various operating mode of a Gunn diode.	7
	(d)	Explain parametric up converter and parametric down converter.	7
		Unit-V	
5.	(a)	Differentiate between an E-plane tee and H-plane	
		tee.	2

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(b) Derive the scattering matrix of E-plane Tee.

(c) Explain the microwave bench setup with its block diagram. Describe Bolometer method of power measurement.

(d) Draw the schematic diagram of magic tee. Derive its s-matrix explain working.

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